



△ Open

△ HPA092 EVM modified for VIN = 3.3V and VOUT2 = 2.5V

Title	TPS75003		
Size	Number	Rev	
B	PR409		
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Filename: PR409_bom.xls					
Date: 12/14/2004					
PR409 BOM					
COUNT	RefDes	DESCRIPTION	SIZE	Part Number	MFR
3	C1, C12, C13	Capacitor, POSCAP, 100-uF, 6.3-V, 45-milliohm, 20%	6032 (C)	6TPB100MC	Sanyo
1	C10	Capacitor, Ceramic, 10-pF, 50-V, C0G, 5%	0603	C1608C0G1H100D	TDK
0	C11, C15, C16, C17, C18	Capacitor, Ceramic, xx-uF, xx-V	0603		
2	C2, C4	Capacitor, Ceramic, 0.1-uF, 16-V, X7R, 10%	0603	C1608X7R1C104K	TDK
2	C3, C5	Capacitor, Ceramic, 1000-pF, 50-V, X7R, 10%	0603	C1608X7R1H102K	TDK
1	C6	Capacitor, Ceramic, 1.0-uF, 6.3-V, X5R, 10%	0603	C1608X5R0J105K	TDK
1	C7	Capacitor, Ceramic, 0.01-uF, 50-V, X7R, 10%	0603	C1608X7R1H103K	TDK
3	C8, C9, C14	Capacitor, Ceramic, 10-uF, 10-V, X5R, 20%	0805	C2012X5R1A106MT	TDK
1	D1	Diode, Schottky, 1A, 20V	457-04	MBRM120	On Semi
1	D2	Diode, Schottky, 3.0-A, 20-V	SMC	SS32	Vishay
8	J1- J8	Header, 2-pin, 100mil spacing, (36-pin strip)	0.100 x 2	PTC36SAAN	Sullins
2	JP1, JP3	Header, 3-pin, 100mil spacing, (36-pin strip)	0.100 x 3	PTC36SAAN	Sullins
1	JP2	Header, 2-pin, 100mil spacing, (36-pin strip)	0.100 x 2	PTC36SAAN	Sullins
1	L1	Inductor, SMT, 5.0-uH, 2.9-mA, 24-milliohms	0.264 sq	CDRH6D38-5R0	Sumida
1	L2	Inductor, SMT, 7.3-uH, 3.2-A, 39-milliohm	0.327 X 0.327	CDRH8D28-7R3	Sumida
2	Q1, Q2	MOSFET, P-ch, 20-V, 4.7-A, 39-milliOhm	SOT23	Si2323DS	Vishay
3	R1, R2, R3	Resistor, Chip, 100k-Ohms, 1/16-W, 1%	0603	Std	Std
1	R10	Resistor, Chip, 0-Ohms, 1/16W, 5%	0603	Std	Std
0	R11	Resistor, Chip, xx-Ohms, 1/16-W, 1%	0603		
2	R4, R5	Resistor, Chip, 0.033-Ohms, ¼ W, 1%	1210	Std	Std
2	R6, R8	Resistor, Chip, 619k-Ohms, 1/16-W, 1%	0603	Std	Std
1	R7	Resistor, Chip, 154k-Ohms, 1/16-W, 1%	0603	Std	Std
1	R9	Resistor, Chip, 604k-Ohms, 1/16-W, 1%	0603	Std	Std
1	U1	IC, Triple Channel DC/DC Converter	QFN-20	TPS75003RGY	TI
3	--	Shunt, 100-mil, Black	0.100	929950-00	3M

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